



life.augmented

# **MEMS sensors in motor machinery applications Condition monitoring for Industry 4.0**

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June 2023





~600

People



>400

Patents



>150

Product & SW libraries

## ST Milan - The home of MEMS



x2

Dual fab source



>6Mu/d

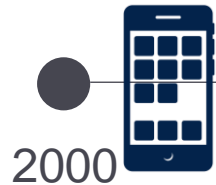
Best-in-class service



27B

Shipped sensors

# 23 years & 27 billion MEMS at ST



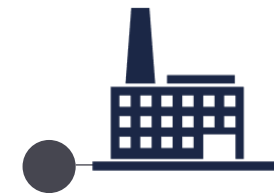
2000

Entering the  
consumer market



2014

Automotive qualified  
MEMS sensors



2015

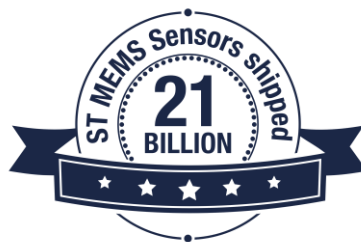
MEMS sensors for  
industrial applications

2023  
Ongoing MEMS  
R&D and new  
developments

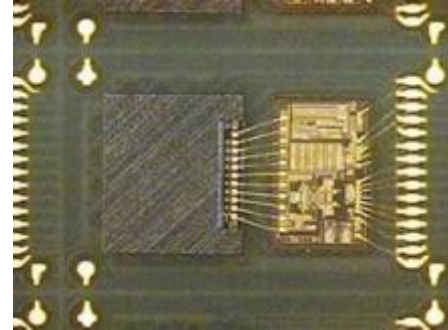
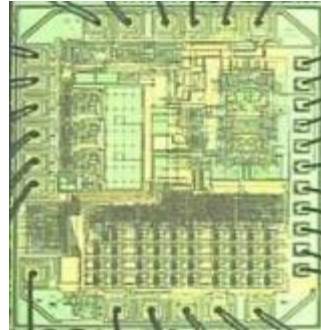
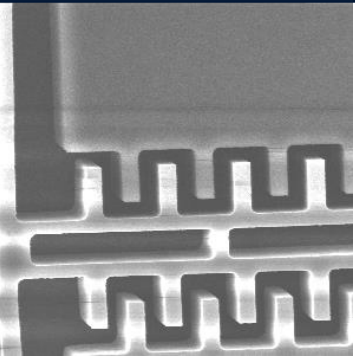


Sensors

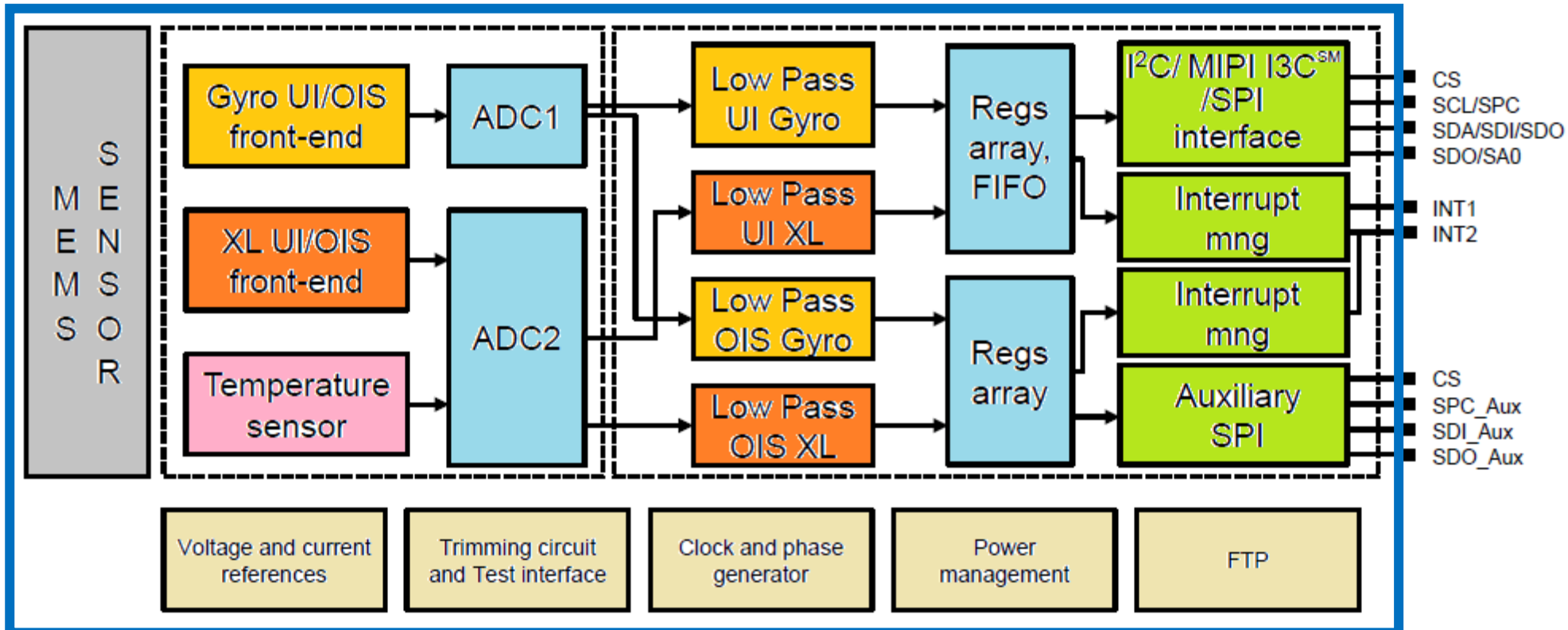
Actuators



# Device block example



- MEMS is Micro ElectroMechanical Systems
- MEMS contain movable 3D structure
- Structure move according to external displacement

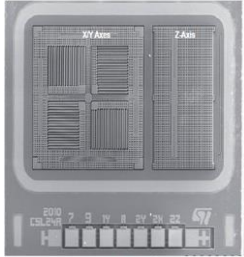


# Brief of ST MEMS sensors



# Accelerometer

## Linear acceleration measurement

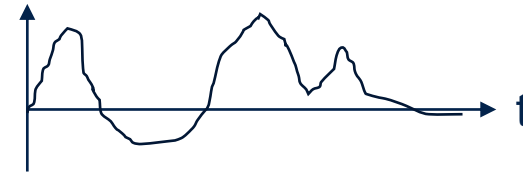
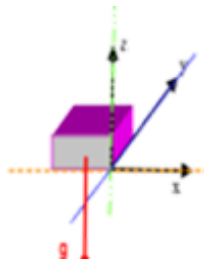
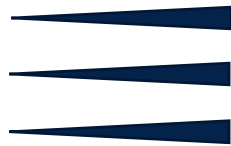
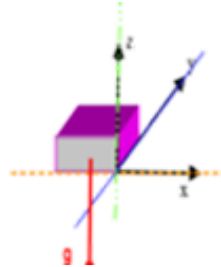


1. Accelerometer can sense linear acceleration.
2. Linear acceleration can be expressed in two forms:

$$\mathbf{A} = \frac{V_2 - V_1}{\Delta t}$$

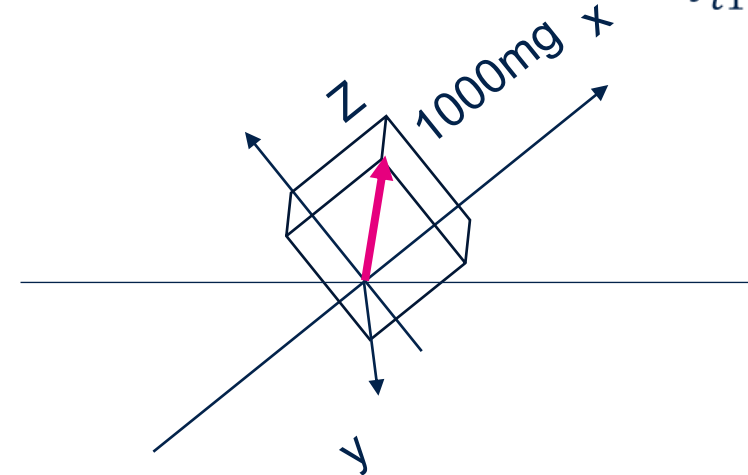
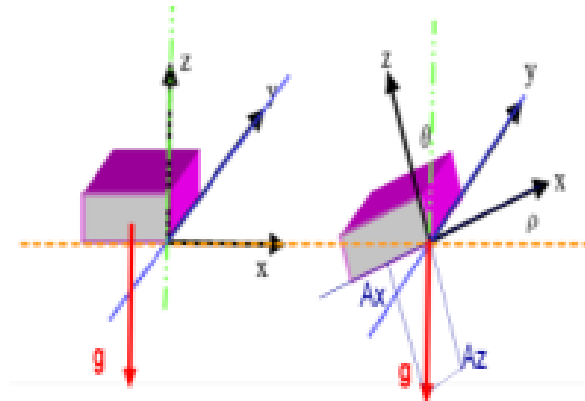
and

$$\mathbf{A} = \frac{\mathbf{F}}{m}$$



$$v(t) = \int_{t_1}^{t_2} A(t) dt$$

$$d = \int_{t_1}^{t_2} v(t) dt$$



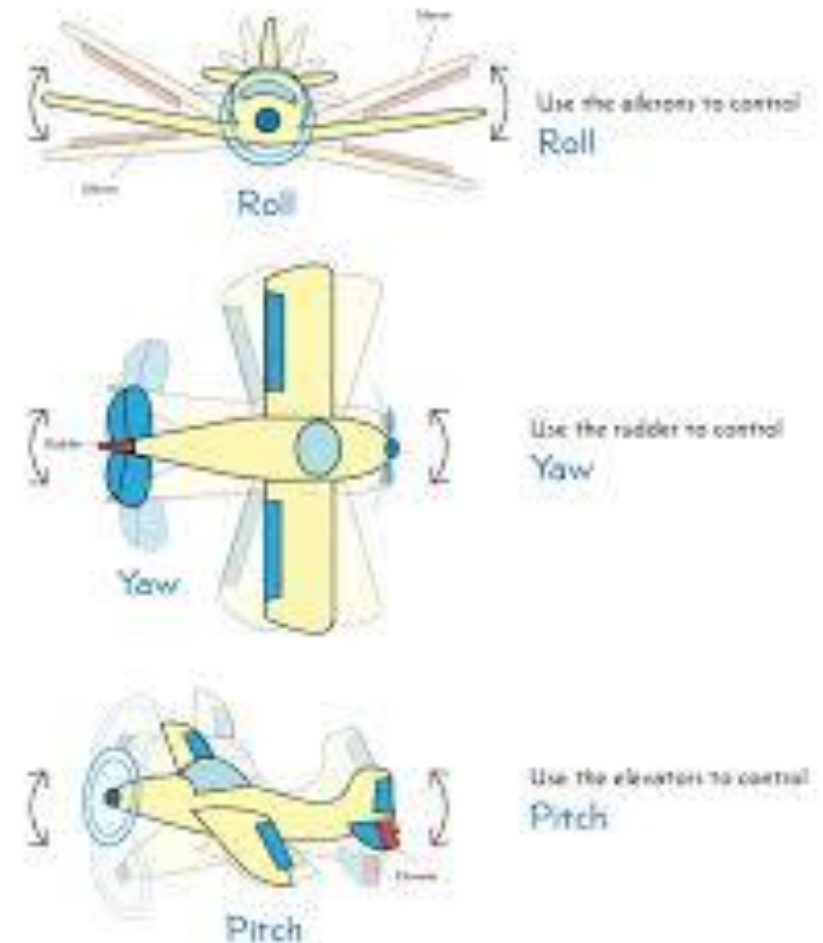
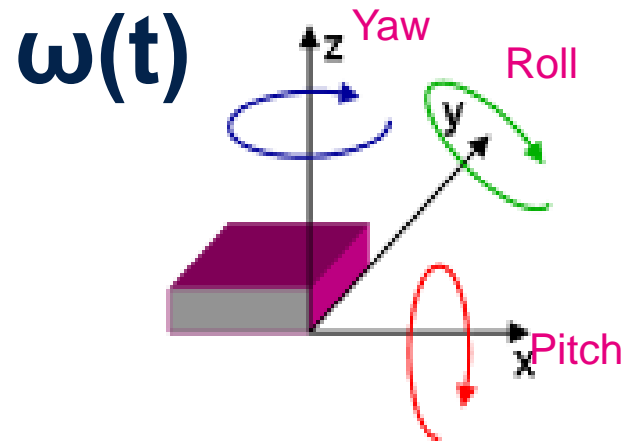
3. Output from sensor is acceleration and always expressed in mg or m/s<sup>2</sup>
4. It can be used to sense the linear acceleration (m/s<sup>2</sup>), tilt, shocks, freefall, orientation detection, vibrations, etc.

# Gyroscope

## Rotation speed measurement

1. Gyroscope can sense the rotation speed or angular rate.
2. Angular rate can be expressed in:

$$\theta = \int_{t_1}^{t_2} \omega(t) dt$$

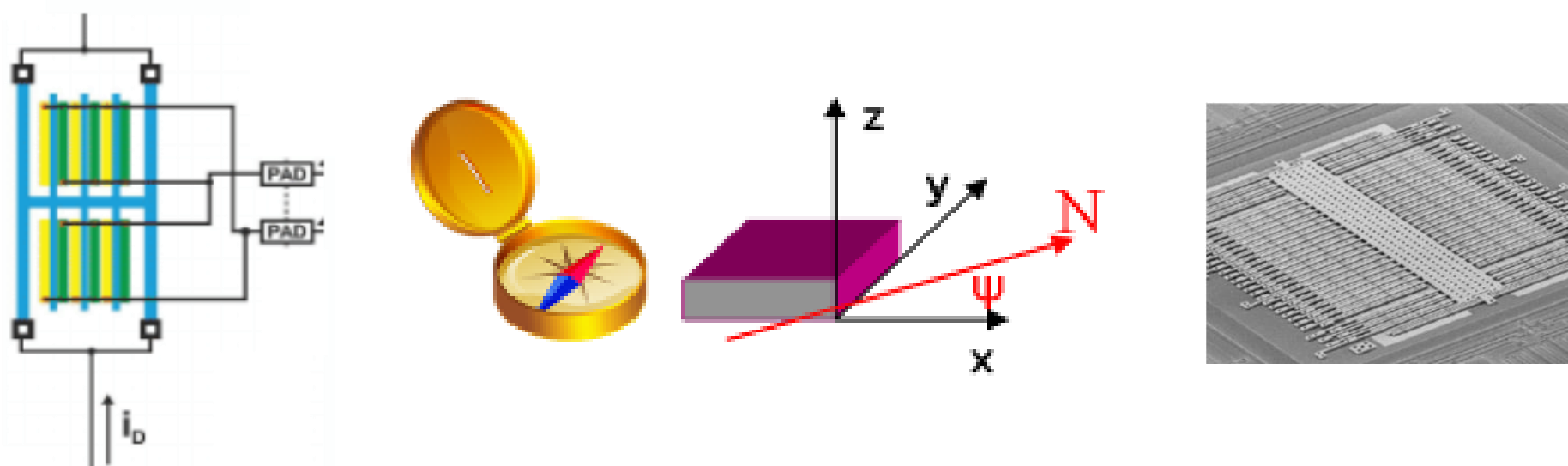


3. Output from gyroscope is in mdps ( $m^\circ /s$ ).
4. Gyroscope can be used to measure the angular rate, number of revolutions (spin), rotation of mechanical part etc.

# Magnetometer

## Magnetic field measurement

1. Magnetometer can sense **magnetic field**
2. Output of magnetic B is expressed in mGS



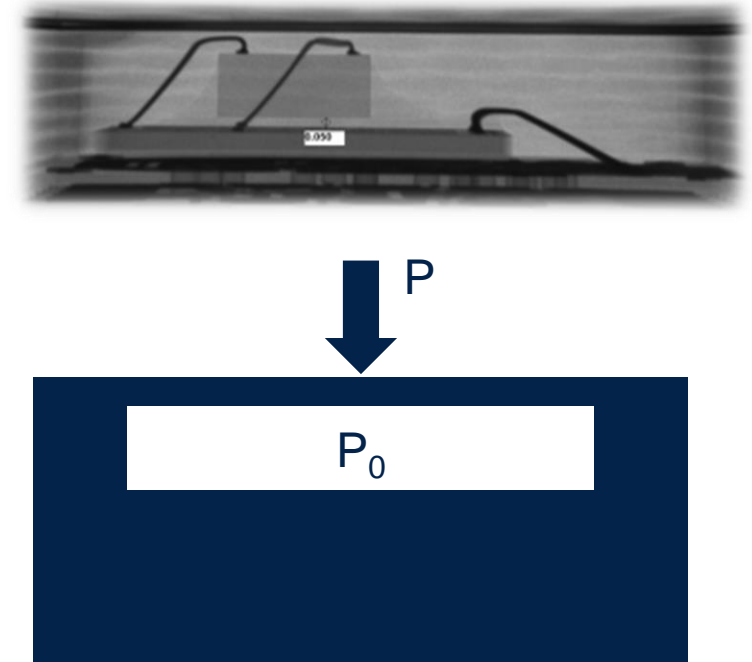
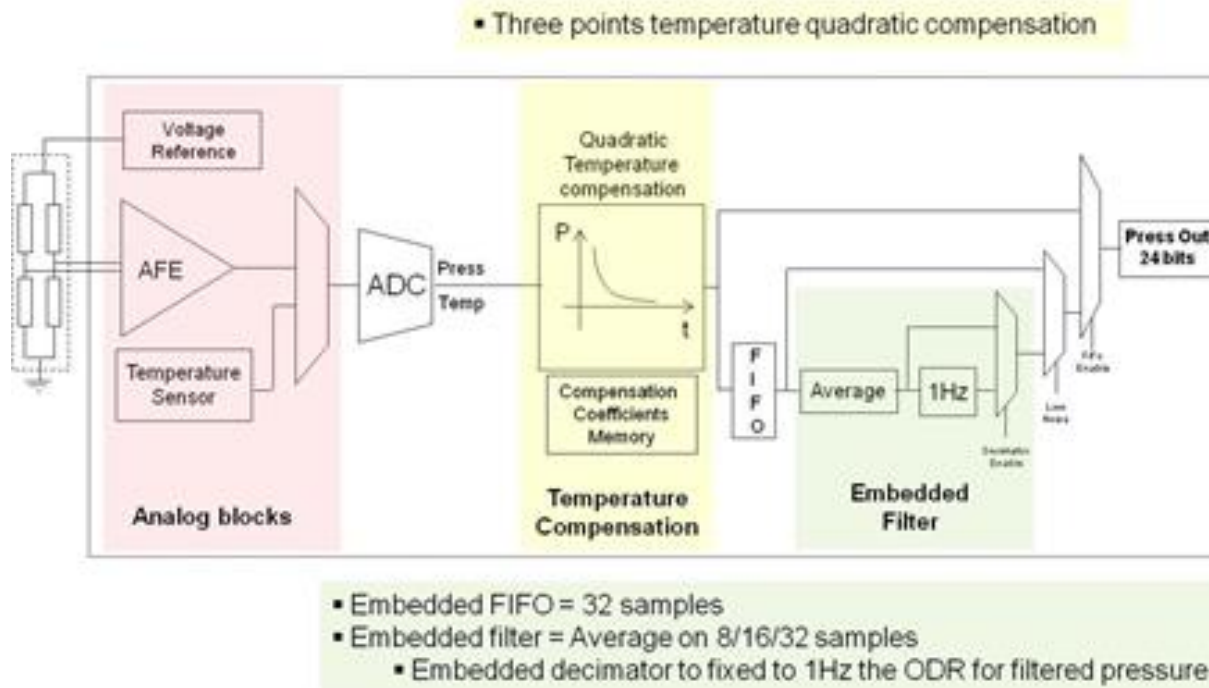
3. Magnetometer can sense the magnetic field (gauss) strength, which can be used to compute the absolute pointing direction with reference to geographical North



# Pressure sensor

## Ambient pressure measurement

1. Pressure sensor can measure ambient pressure which can be air or liquid
2. Output of pressure sensor is expressed in mBar or hPa

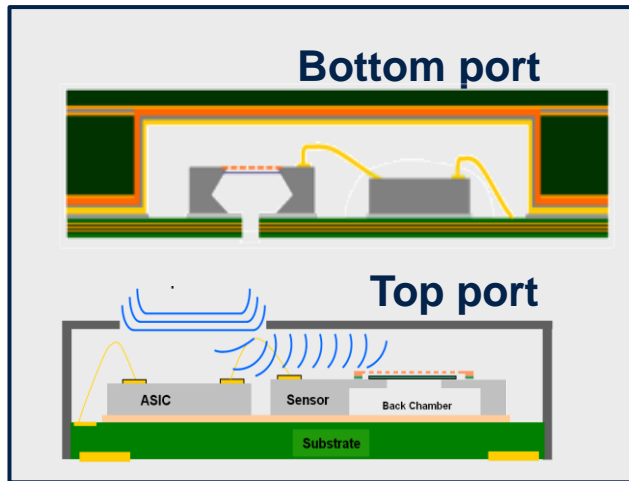


3. Pressure sensor can be used to monitor air speed, altitude, and atmospheric pressure

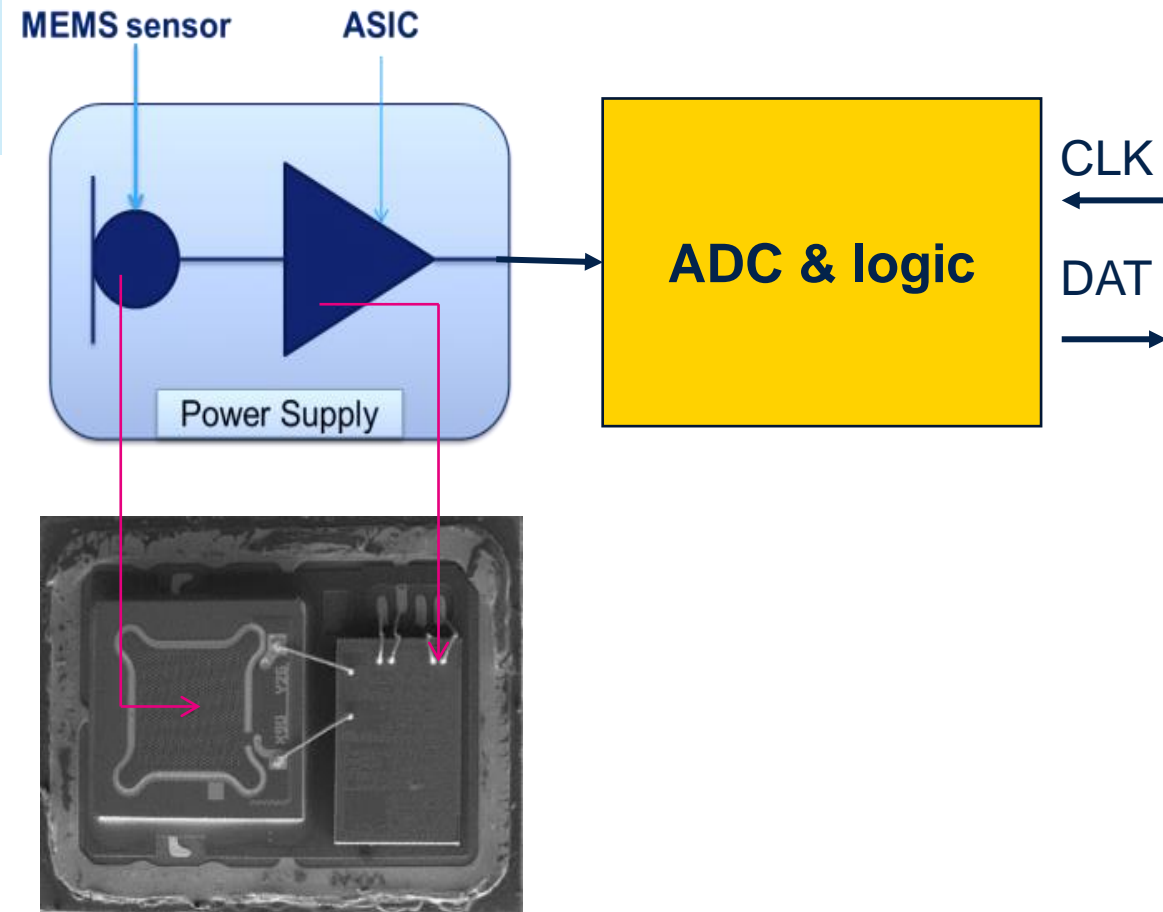
# MEMS microphone

## Acoustic measurement

1. MEMS microphone can **pick up voice from environment**
2. Sound pressure is expressed in dB SPL in PDM for digital MIC or mV for analog MIC

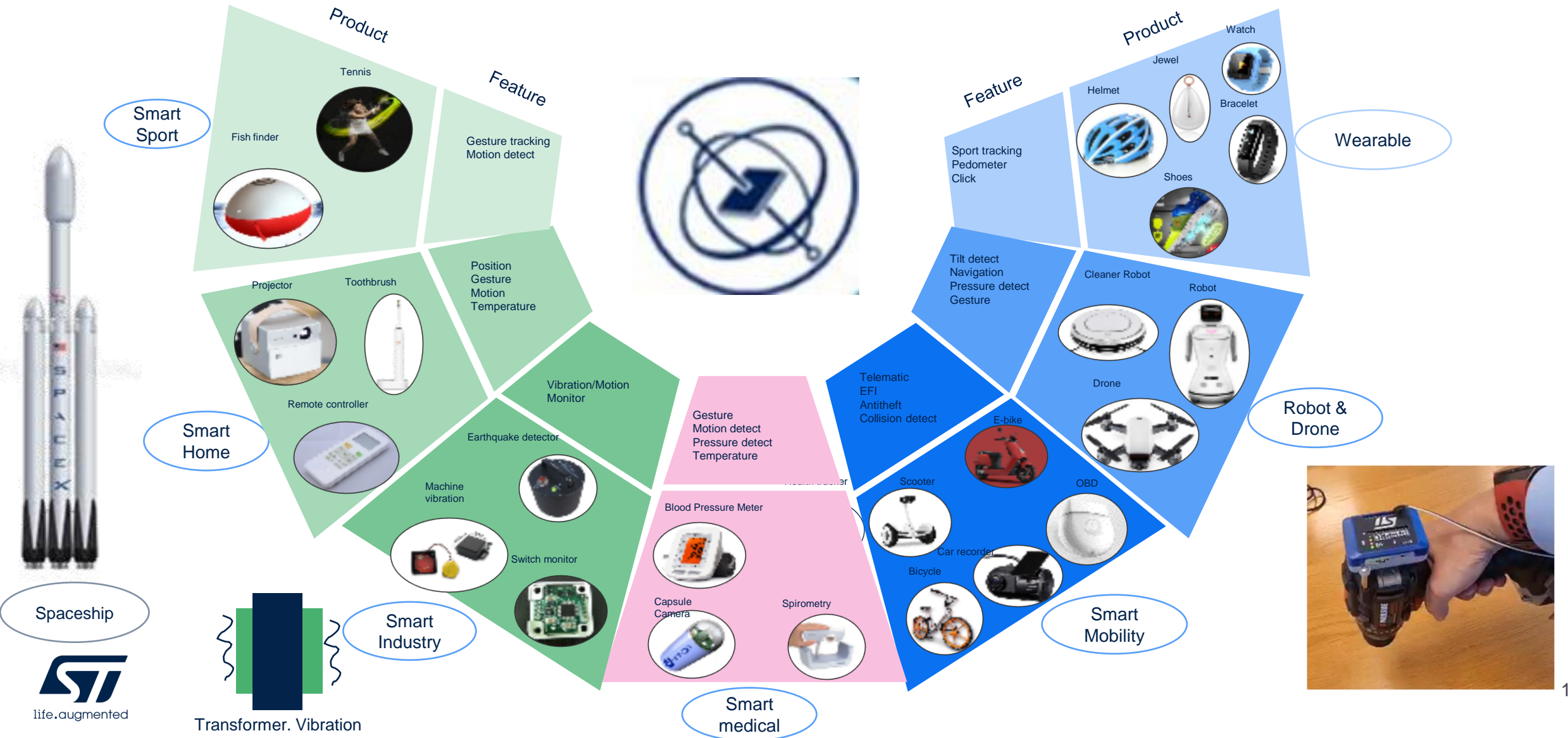


- Small form factor
- Allowed reflow
- Better temperature coefficient
- Better part-part matching



# ST MEMS sensors are everywhere

## Applications



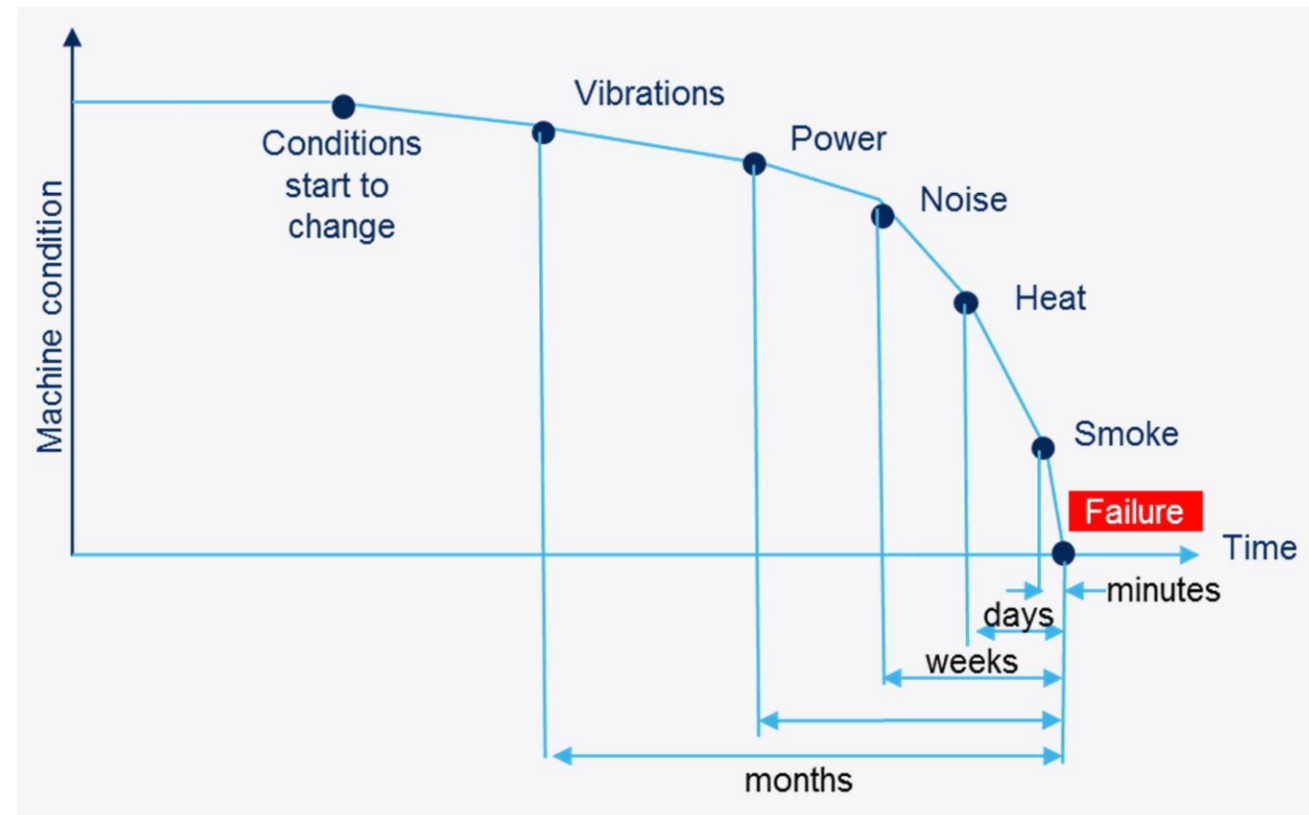
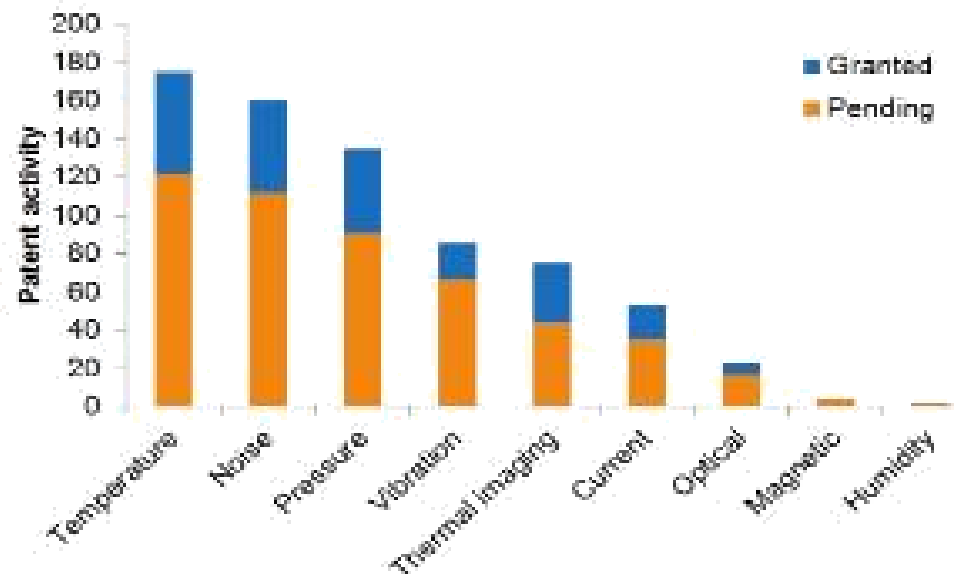
# Predictive maintenance



# Predictive maintenance starts with condition monitoring

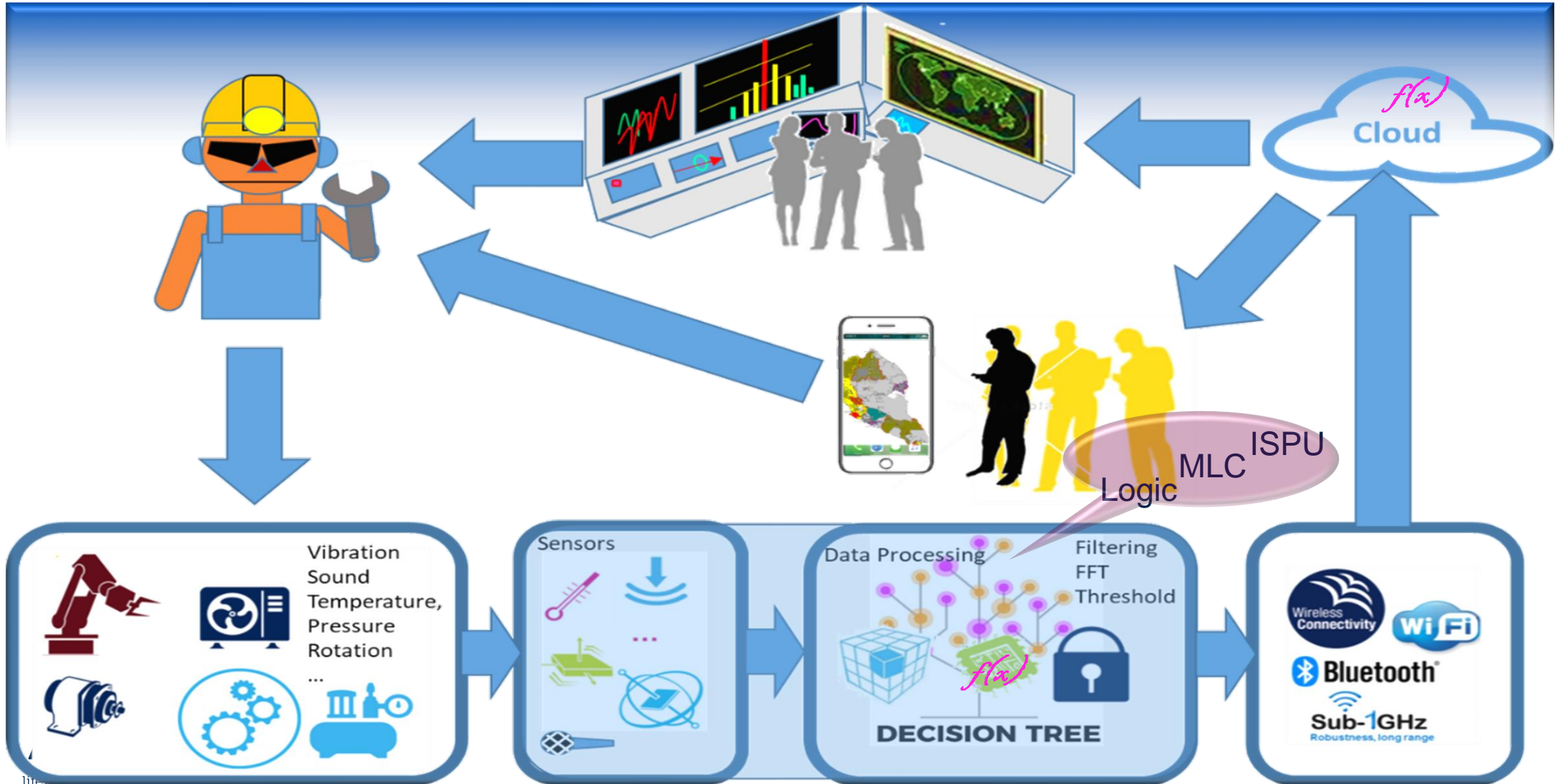
A different business model based on early sign detection, where sensors play a key role

Activities	Tradition	Predictive maintenance
Failure prevention	NA	Yes
Health condition	NA	Yes
Interactive	Human → machine	Machine → human
Diagnostic tool	Human	Sensor



# Topology of industrial 4.0

## The ecosystem



# Predictive maintenance contributing to profits



**12%** Savings of scheduled repair costs

Reduction of cost  
due to maintenance

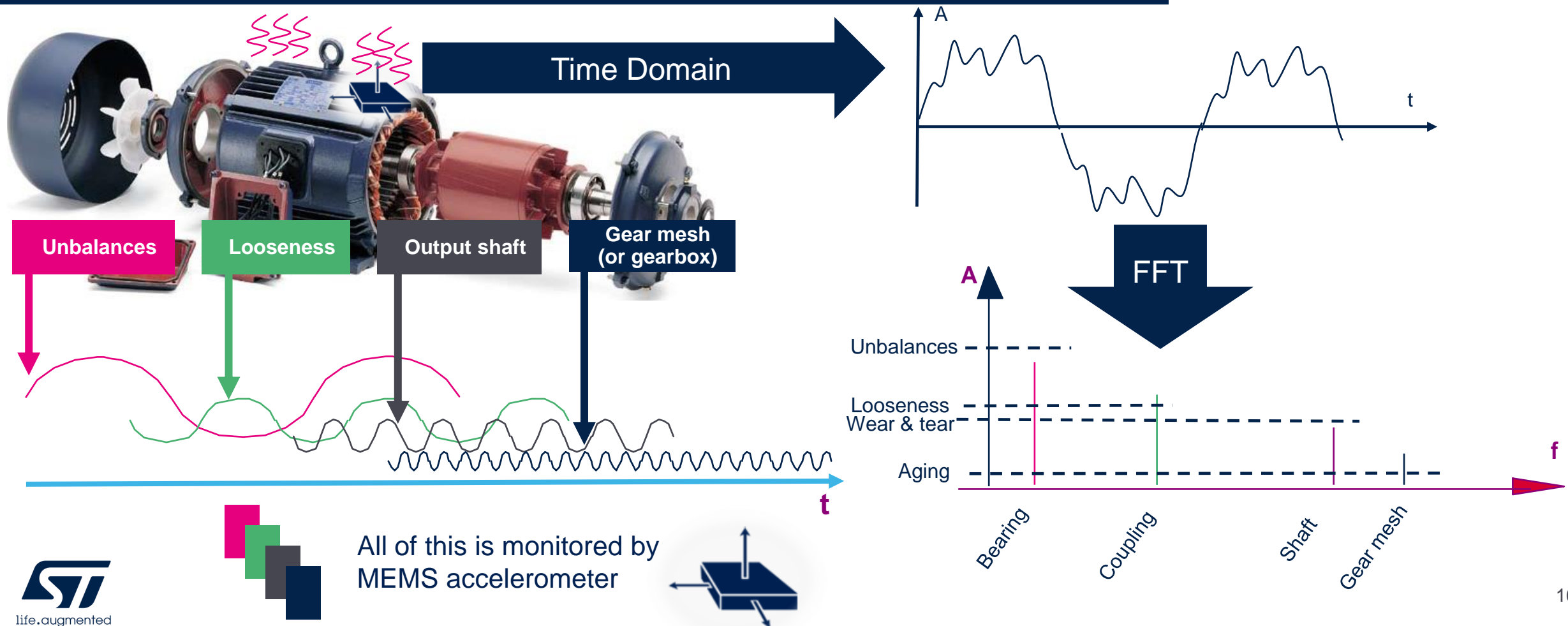
**30%**

**50%** Reduction of machine downtime

Fewer breakdowns **70%**

# Vibration monitoring use-case with accelerometer

When we consider mechanical vibrations, a typical architecture becomes...



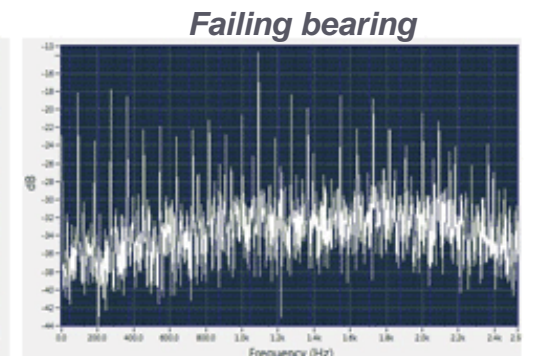
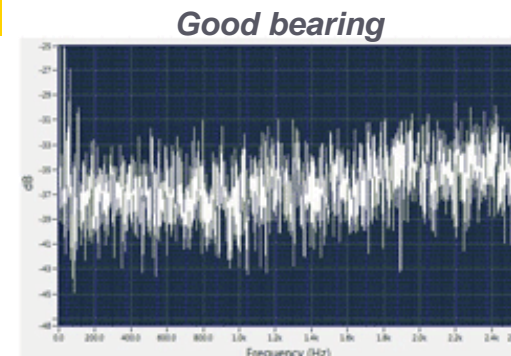
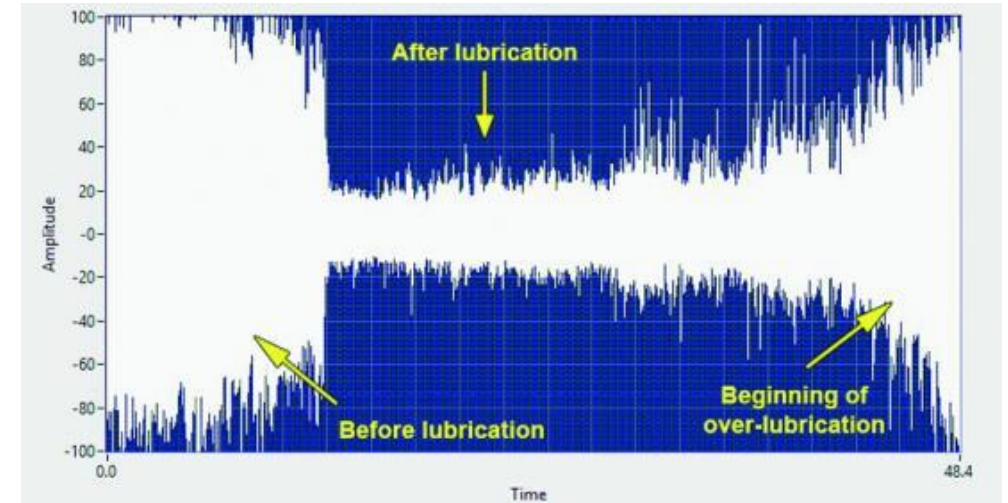


# Predictive monitoring using audio

Most common maintenance applications that can be applied at your plant today:

- Air leak detection of compressed air equipment
- Vibration monitor: all rotating equipment produces frictional forces with high-frequency ultrasonic signatures that are often masked by ambient plant noise and low frequency vibrations
- Compressor valve inspections
- Acoustic lubrication
- Heat exchanger and condenser leaks
- Hydraulic systems
- Pump cavitation

**Amplitude and frequencies matter**



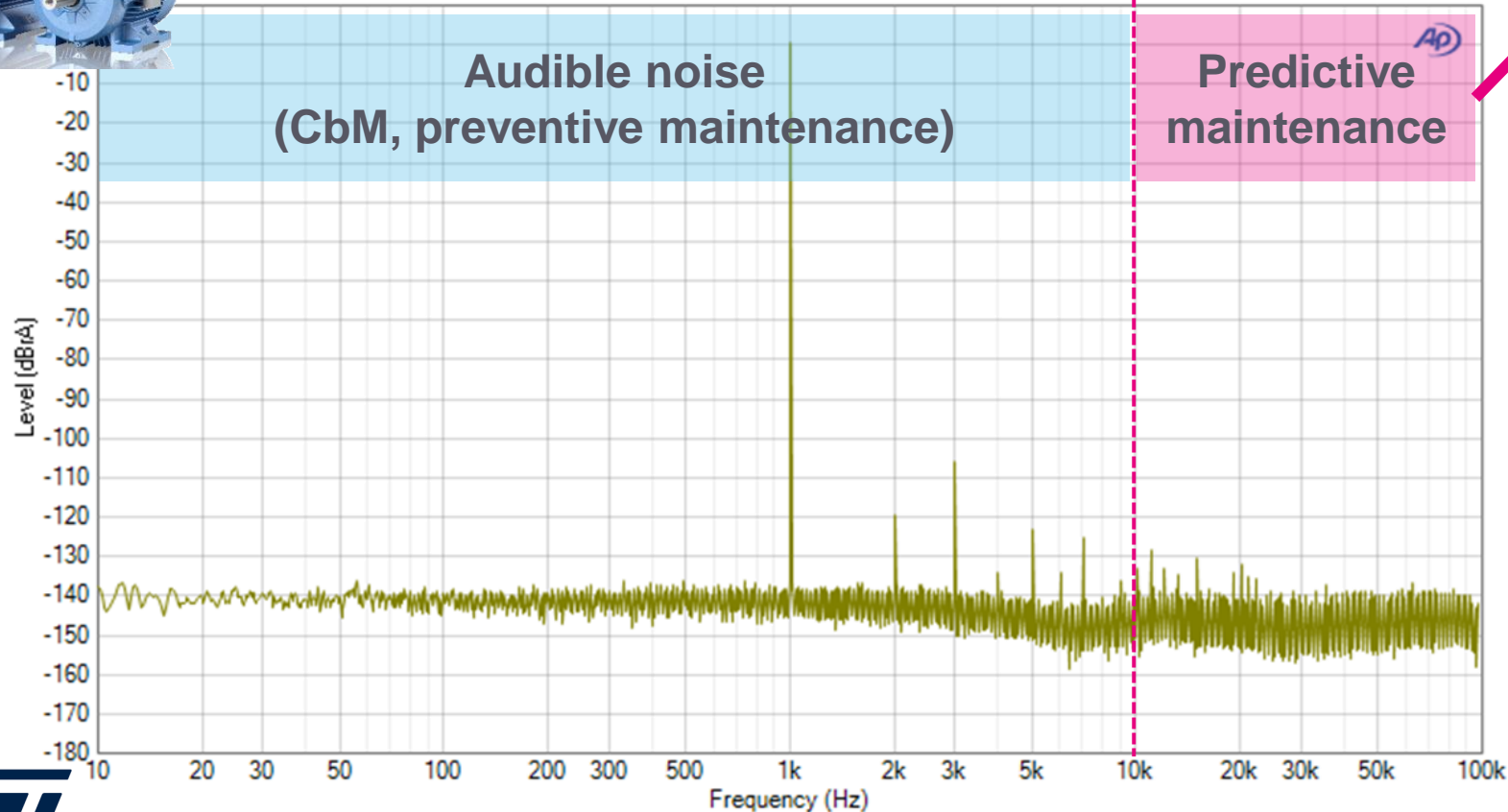
# Audio frequency indicators

## Ultrasound – earlier diagnostic

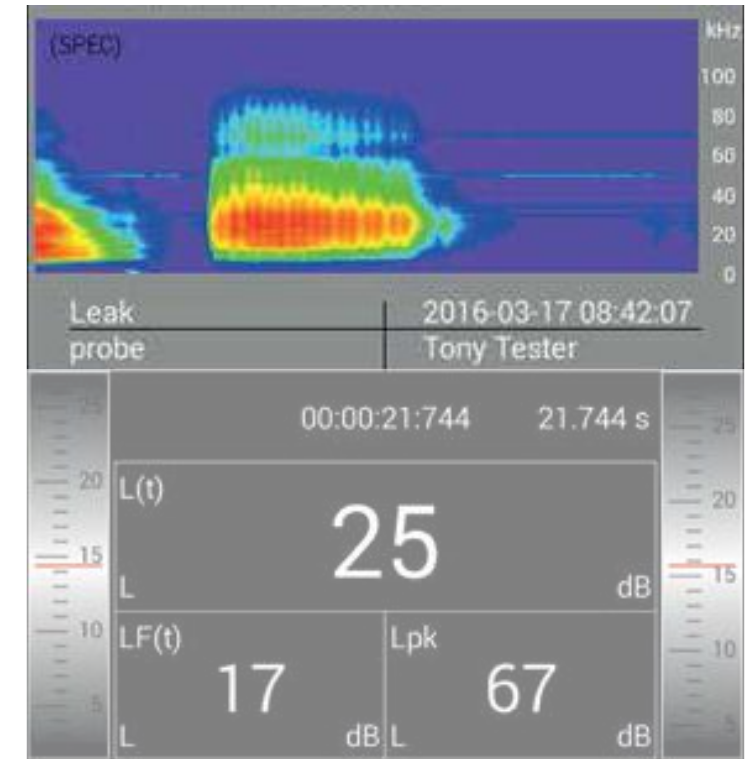


Standard audio bandwidth

Ultrasonic



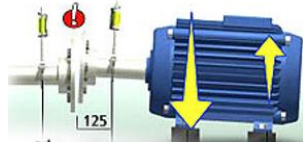
Post processing analysis  
ultrasonic frequencies to detect and  
classify leaks



# Recommended parts

# Design your industrial IoT solution

## Use cases



Unbalance  
Looseness  
Misalignment



Roller bearings  
Gearing  
Cavitation



Bearings  
Gear Box  
Lubrication

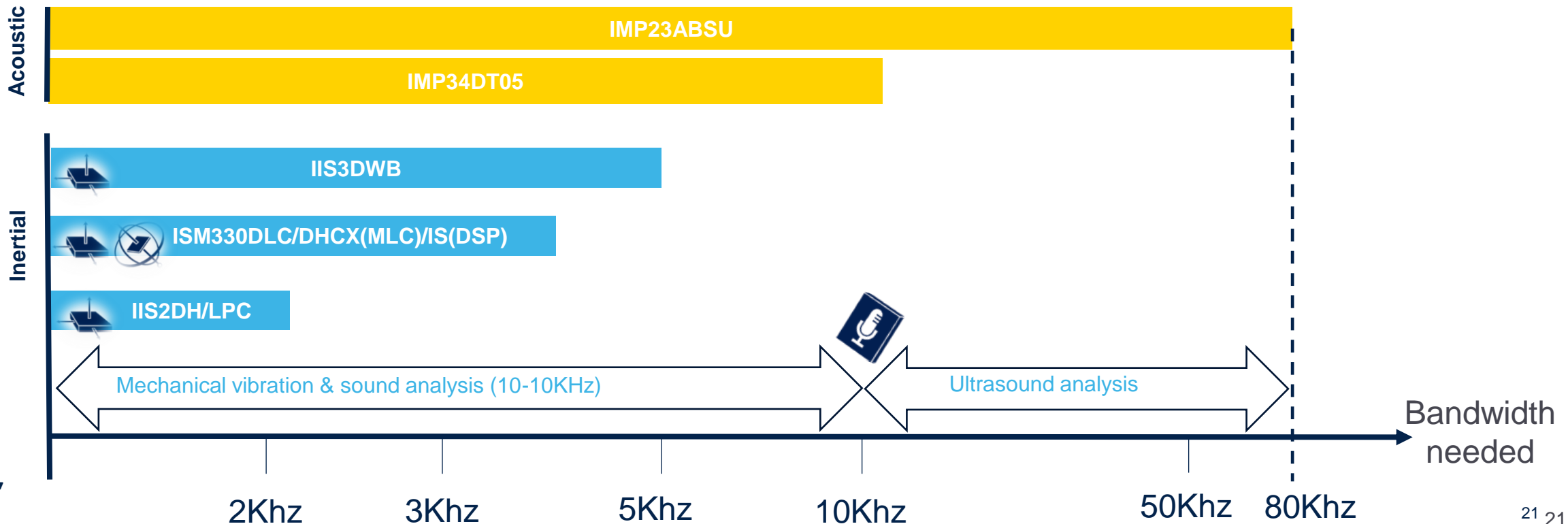


Fan bearings  
Venting occlusion  
Cooling failure



Type of defect/wear

## Sensing technologies







# ST sensors longevity program

6-axis IMU

## I3G4250D



4 x 4 x 1 mm

- 3-axis digital gyroscope
- High linearity and stability over temperature and time

## ISM330DLC



2.5 x 3 x 0.86 mm

- Dual Channel output
- Low power
- Smart features
- Axel with wide BW (3kHz) and low noise

- Cur Cons HP: **0.75 mA** combo
- FS: **gyro up to 2000 dps; axel up to 16 g**

## ISM330DHCX



2.5 x 3 x 0.86 mm

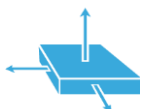
- Enhanced machine learning core and FSM
- High accuracy and stability: (BI: 3°/hr)
- Axel with wide BW (3kHz) and low noise

- Cur Cons HP: **0.90 mA** gyro; **1.2 mA** combo
- FS: **gyro up to 4000 dps; axel up to 16 g**
- Extended top: **-40°C +105°C**

MP: Q2 2019

Axel

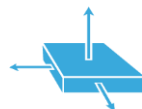
## IIS2DH



2 x 2 x 1 mm

- Low power
- Wide BW (2 kHz)

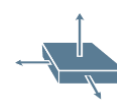
## IIS2DLPC



2 x 2 x 0.7 mm

- Ultralow power
- High versatility: on the fly changes from ultralow power to high resolution/high performance modes

## IIS3DWB

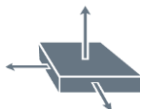


2.5 x 3 x 0.86 mm

- **3-axis digital axel**
- **Ultra wide and Flat bandwidth (>5Khz)**
- Low noise (90 µg/√Hz)
- Low power (1.1mA)
- Extended top: **-40°C +105°C**
- **Ideal for vibration monitoring**

MP: Q3 2019

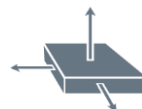
## IIS328DQ



4 x 4 x 1.8 mm

- Extended top: **-40°C +105°C**
- QFN package

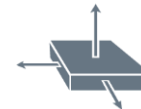
## IIS3DHHC



5 x 5 x 1.7 mm

- **3 axis digital inclinometer**
- High resolution and stability over temperature and time
- High end ceramic package

## IIS2ICLX



5 x 5 x 1.7 mm

- **2 axis digital inclinometer**
- **Enhanced machine learning core and FSM**

- Ultra High resolution and stability over temperature and time
- Low power
- Extended top: **-40°C +105°C**

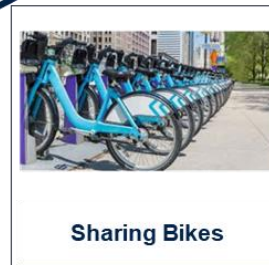
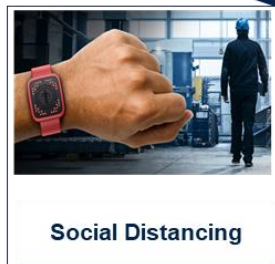
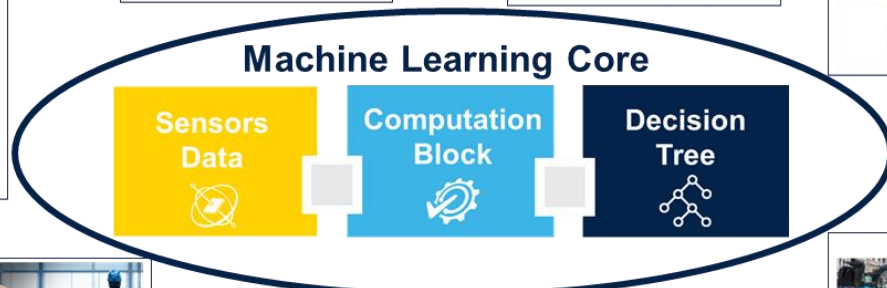
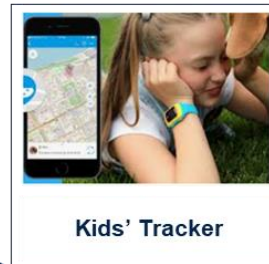
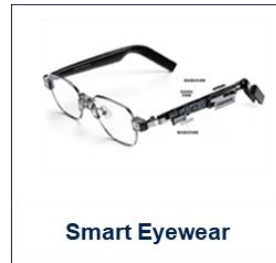
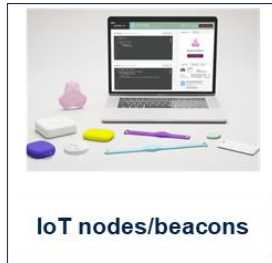
- Cur Cons: **0.42 mA**
- FS: **± 0.5/1.0/2.0/4.0**

MP: Q3 2019

# Real edge computing with Machine Learning core

## Simple, intuitive, and extremely low power

- Mean
- Variance
- Energy
- Peak-to-Peak
- 0 crossing
- Peak detector
- Min & Max



	Activity recognition	<b>LSM6DSOX</b> MLC: 256 nodes FS: $\pm 2000$ dps, $\pm 16$ g G_OffDr: $\pm 0.010$ dps/ $^{\circ}$ C Cus cons: 0.55 mA combo T <sub>op</sub> : -40 $^{\circ}$ C +105 $^{\circ}$ C
	Gym activity recognition	
	Airplane mode detection	
	Virtual Reality	<b>LSM6DSRX</b> MLC: 512 nodes FS: $\pm 4000$ dps, $\pm 16$ g G_OffDr: $\pm 0.005$ dps/ $^{\circ}$ C Cus cons: 1.2 mA combo T <sub>op</sub> : -40 $^{\circ}$ C +85 $^{\circ}$ C
	Sensor Fusion	
	Vehicle stationary detection	
	Smart antennas	<b>ISM330DHCX</b> Industrial MLC: 512 nodes FS: $\pm 4000$ dps, $\pm 16$ g G_OffDr: $\pm 0.005$ dps/ $^{\circ}$ C Cus cons: 1.2 mA combo T <sub>op</sub> : -40 $^{\circ}$ C +105 $^{\circ}$ C
	Industrial IoT	
	Dynamic inclinometers	
	Structural health monitoring	<b>IIS2ICLX</b> MLC: 512 nodes FS: $\pm 3$ g Ultra low noise: 15 $\mu$ g/ $\sqrt{\text{Hz}}$ X_OffDr: $< 0.075$ mg/ $^{\circ}$ C T <sub>op</sub> : -40 $^{\circ}$ C +105 $^{\circ}$ C
	Leveling instruments	
	Equipment installation and monitoring	

# ISPU added value



## Ultra low power consumption

- Efficiency of the embedded DSP (digital signal processing)
- Very low data exchange with external MCU (MCU stay in sleep mode most of the time)



## Ultra low latency

- Processing / decision taken directly in the sensor



## Easily programmable with C language or with commercial or open-source AI models

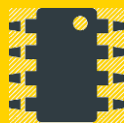


NANOEDGE AI



## Data privacy & security

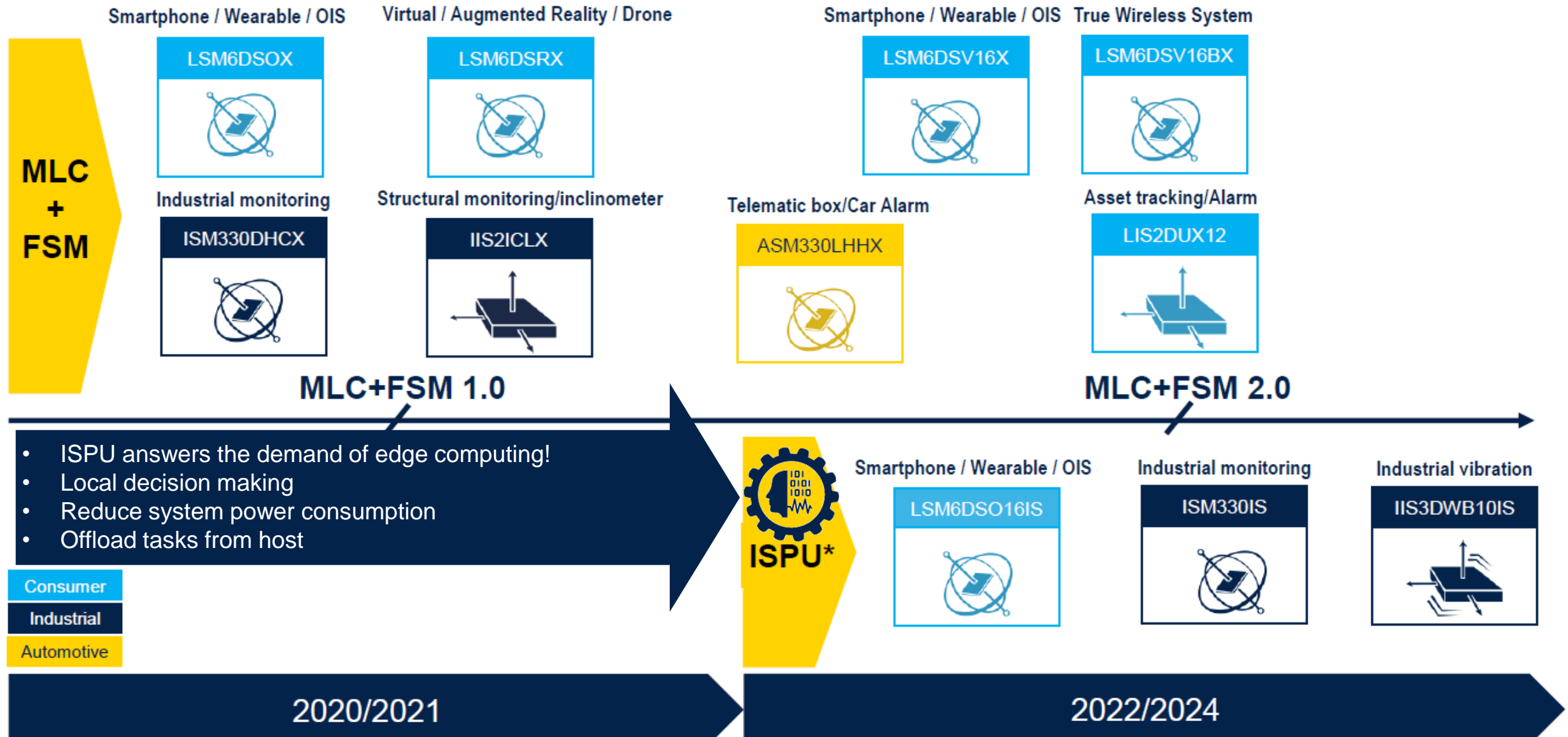
- Sensor data are locally processed and not provided outside



## Integration / miniaturization

- MEMS mixed-signal state-of-the-art technology node
- No special purpose package

# Intelligent sensor processing unit (ISPU)





# Our technology starts with You



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